Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	134	(microwave with (epoxy or encapsulant)) and (chip or die or chips or dies)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/01/12 10:29
L2	67	L1 and (@ad<"19991230")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/01/12 10:30
L3	1066	((laser or microwave) with (epoxy or encapsulant)) and (chip or die or chips or dies)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/01/12 10:31
L4	472	L3 and (@ad<"19991230")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/01/12 11:14
L5	80	L4 and ((laser or microwave) with (cure or curing or cured))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/01/12 10:36
L6	15	L4 and (microwave with (cure or curing or cured))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/01/12 10:37
L7	16	L4 and (microwave same (cure or curing or cured))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/01/12 10:53
L8	5	219/678.ccls. and (chip or chips or die or dies) and (microwave same (cure or curing or cured))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/01/12 10:54

L9	0	219/690.ccls. and (chip or chips or die or dies) and (microwave same (cure or curing or cured))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/01/12 10:54
L10	8	219/759.ccls. and (chip or chips or die or dies) and (microwave same (cure or curing or cured))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/01/12 10:59
L11	139	"156"/$.ccls. and (chip or chips or die or dies) and (microwave same (cure or curing or cured))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/01/12 11:14
L12	98	L11 and (@ad<"19991230")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/01/12 11:16
L13	95	L12 not L5	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/01/12 11:15
L14	9	L13 and semiconductor	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/01/12 11:15
L15	14	L13 and ((integrated adj circuit) or semiconductor)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/01/12 11:15
L16	14	L15 and (@ad<"19991230")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/01/12 11:17

| L17 | 8 | L16 and (sink or spreader) | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/01/12 11:17 |